EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	((chip near2 on near2 board) and semiconductor and die and (heat near2 sink near2 cap) and (adhesive near4 gel near2 silicon$2) and elastomer and hole and encapsulant).clm.	US-PGPUB	OR	ON	2007/02/12 13:27
L2	0	((chip near3 board) and semiconductor and die and (heat near2 sink near2 cap) and (adhesive near4 gel near2 silicone) and elastomer and hole and encapsulant).clm.	US-PGPUB	OR	ON	2007/02/12 13:28